

Low-Noise LVDS Clock Generator

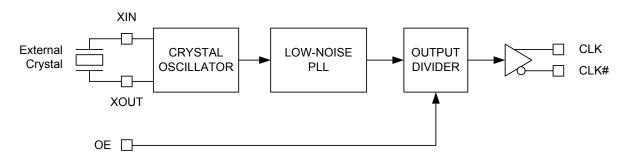
Features

- Output: One low-voltage differential signal (LVDS) output pair
- Output frequency: 125 MHz
- Input: 25-MHz external crystal
- RMS phase jitter:
 At 125 MHz (12 kHz to 20 MHz offset): 0.65 ps typical
- Package: Pb-free 8-pin thin shrunk small outline package (TSSOP)
- Supply voltage: 3.3 V or 2.5 V
- Temperature range: Commercial or industrial

Logic Block Diagram

Functional Description

The CY2XL13 is a phase-locked loop (PLL)-based high-performance clock generator that uses Cypress's low-noise voltage control oscillator (VCO) technology to achieve less than 1-ps typical RMS phase jitter. The CY2XL13 uses an external crystal reference input to generate one LVDS output pair, which can be asynchronously enabled/disabled with an OE pin. The device operates at 3.3 V or 2.5 V.



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Pinout

Figure 1. 8-pin TSSOP pinout



Pin Definitions

8-pin TSSOP

Pin Number	Pin Name	I/О Туре	Description	
1, 8	VDD	Power	3.3-V or 2.5-V power supply. All supply current flows through pin 1	
2	VSS	Power	Ground	
3, 4	XOUT, XIN	XTAL output and input	Parallel resonant crystal interface	
5	OE	CMOS input	Output enable: When high, the output is enabled. When low, the output is high impedance.	
6, 7	CLK#, CLK	LVDS output	Differential clock output	

Frequency Table

Part Number	Crystal Frequency	Output Frequency	Pin 5 Eurotion	RMS Phase Ji	tter (Random)
Fait Nullibei	Crystal requency	Output I requeitcy	cy Pin 5 Function Offset Range		Jitter (Typical)
CY2XL13ZXC01	25 MHz	125 MHz	OE	12 kHz to 20 MHz	0.65 ps
CY2XL13ZXI01					



Absolute Maximum Conditions

Parameter	Description	Condition	Min	Max	Unit
V _{DD}	Supply voltage		-0.5	4.4	V
V _{IN} ^[1]	Input voltage, DC	Relative to V _{SS}	-0.5	V _{DD} + 0.5	V
Τ _S	Temperature, Storage	Non operating	-65	150	°C
TJ	Temperature, Junction		-	135	°C
ESD _{HBM}	Electrostatic discharge (ESD) protection (human body model)	JEDEC STD 22-A114-B	2000	-	V
UL-94	Flammability rating	At 1/8 in.	V-0		-
$\Theta_{JA}^{[2]}$	Thermal resistance, junction to	0 m/s airflow	1(00	°C/W
	ambient	1 m/s airflow	9)1	Ī
		2.5 m/s airflow	8	37	Ī

Operating Conditions

Parameter	Description	Min	Max	Unit
V _{DD}	3.3-V supply voltage	3.135	3.465	V
	2.5-V supply voltage	2.375	2.625	V
T _A	Ambient temperature, commercial	0	70	°C
	Ambient temperature, industrial	-40	85	°C
T _{PU}	Power-up time for all V_{DD} to reach minimum specified voltage (ensure power ramp is monotonic)	0.05	500	ms

Notes

- The voltage on any input or I/O pin cannot exceed the V_{DD} pins during power-up.
 Simulated using Apache Sentinel TI software. The board is derived from the JEDEC multilayer standard. It measures 76 x 114 x 1.6 mm and has 4-layers of copper (2/1/1/2 oz.). The internal layers are 100% copper planes, while the top and bottom layers have 50% metallization. No vias are included in the model.



DC Electrical Characteristics

Parameter	Description	Test Conditions	Min	Тур	Max	Unit
I _{DD} ^[3]	Power supply current with output terminated	V _{DD} = 3.465 V, OE = V _{DD} , output terminated	-	-	120	mA
		V _{DD} = 2.625 V, OE = V _{DD} , output terminated	-	-	115	mA
V _{OD} ^[4]	LVDS differential output voltage	V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between CLK and CLK#	247	_	454	mV
$\Delta V_{OD}^{[4]}$	Change in V _{OD} between complementary output states	V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between CLK and CLK#	-	_	50	mV
V _{OS} ^[5]	LVDS offset output voltage	V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between CLK and CLK#	1.125	_	1.375	V
ΔV _{OS}	Change in V _{OS} between complementary output states	V_{DD} = 3.3 V or 2.5 V, R _{TERM} = 100 Ω between CLK and CLK#	-	_	50	mV
l _{oz}	Output leakage current	Three-state output, unterminated, measured on one pin while floating the other pin, OE = V_{SS}	-35	_	35	μΑ
V _{IH}	Input high voltage, pin 5		$0.7 \times V_{DD}$	-	-	V
V _{IL}	Input low voltage, pin 5		_	-	0.3 × V _{DD}	V
I _{IH}	Input high current, pin 5	Input = V _{DD}	-	_	115	μA
IIL	Input low current, pin 5	Input = V _{SS}	-50	_	-	μA
C _{IN}	Input capacitance, pin 5		-	15	-	pF
C _{INX}	Pin capacitance, XIN and XOUT		_	4.5	-	pF

Notes

I_{DD} includes ~4 mA of current that is dissipated externally in the output termination resistor.
 Refer to Figure 2 on page 7.
 Refer to Figure 3 on page 7.



AC Electrical Characteristics

Parameter ^[6, 7]	Description	Test Conditions	Min	Тур	Max	Unit
F _{OUT} ^[8]	Output frequency			See note 8		MHz
T _R , T _F ^[9]	Output rise or fall time	20% to 80% of full output swing	-	0.5	1.0	ns
T _{Jitter(φ)} [8, 10]	RMS phase jitter (random)	Offset = 12 kHz to 20 MHz	-	-	1.0	ps
T _{DC} ^[11]	Duty cycle	Measured at zero crossing point	45	-	55	%
T _{OHZ} ^[12]	Output disable time	Time from falling edge on OE to stopped outputs (asynchronous)	_	-	100	ns
T _{OE} ^[12]	Output enable time	Time from rising edge on OE to outputs at a valid frequency (asynchronous)	_	-	120	ns
T _{LOCK}	Startup time	Time for CLK to reach valid frequency measured from the time $V_{DD} = V_{DD(min)}$.	_	-	5	ms

Crystal Characteristics

Parameter	Description	Min	Мах	Unit
МО	Mode of oscillation	Funda	mental	
F ^[8]	requency		ote 8	MHz
ESR	Equivalent series resistance	-	50	Ω
C _S	Shunt capacitance	_	7	pF

Notes

- 6. Not 100% tested, guaranteed by design and characterization. 7. Outputs are terminated with 100 Ω between CLK and CLK#. Refer to Figure 8 on page 8. 8. Crystal frequency, output frequency, and typical phase jitter are listed in Frequency Table on page 3. 9. Refer to Figure 4 on page 7.

- Refer to Figure 7 on page 8.
 Refer to Figure 5 on page 7.
 Refer to Figure 6 on page 7.



Switching Waveforms

Figure 2. Output Voltage Swing

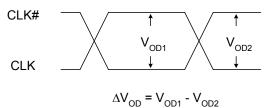


Figure 3. Output Offset Voltage

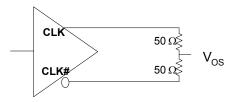


Figure 4. Output Rise or Fall Time

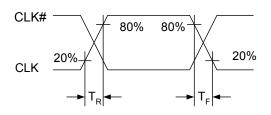
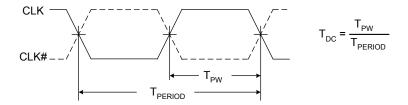
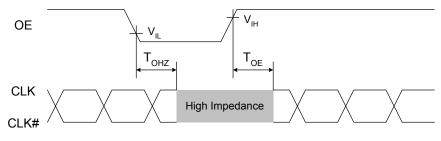


Figure 5. Duty Cycle Timing



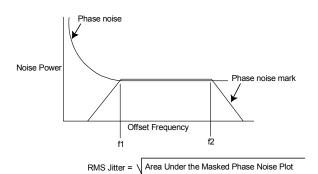






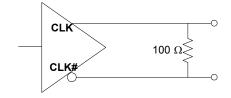
Switching Waveforms (continued)

Figure 7. RMS Phase Jitter



Termination Circuits

Figure 8. LVDS Termination



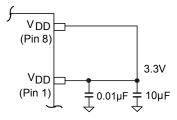


Application Information

Power Supply Filtering Techniques

As in any high-speed analog circuitry, noise at the power supply pins can degrade performance. To achieve optimum jitter performance, use good power-supply isolation practices. Figure 9 illustrates a typical filtering scheme. Because all the current flows through pin 1, the resistance and inductance between this pin and the supply is minimized. A 0.01 or 0.1 μ F ceramic chip capacitor is also located close to this pin to provide a short and low-impedance AC path to ground. A 1 to 10 μ F ceramic or tantalum capacitor is located in the general vicinity of this device and may be shared with other devices.

Figure 9. Power Supply Filtering



Board Layout and OE Pin

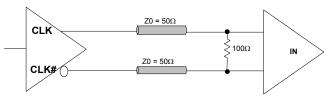
If the Output Enable (OE) function on pin 5 is not needed, it may be connected directly to the V_{DD} plane by a wide trace and multiple vias. This improves heat dissipation. A resistor between OE and V_{DD} is not necessary.

Termination for LVDS Output

The CY2XL13 is designed to drive a standard LVDS load with a 100- Ω termination resistor. Figure 10 shows the standard termination scheme. The termination resistor should always be

located very close to the receiver. To minimize signal reflections from the receiver, the differential impedance (Z_0) of the trace pair should be 100 Ω to match the termination resistor.

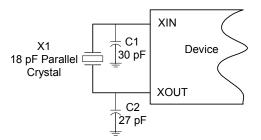
Figure 10. Output Termination



Crystal Interface

The CY2XL13 is characterized with 18 pF parallel resonant crystals. The capacitor values shown in Figure 11 are determined using an 18 pF parallel resonant crystal and are chosen to minimize the ppm error. Note that the optimal values for C1 and C2 depend on the parasitic trace capacitance and are, therefore, layout dependent.

Figure 11. Crystal Input Interface

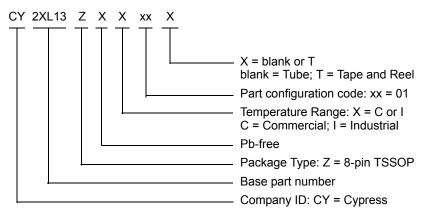




Ordering Information

Part Number	Package Description	Product Flow
CY2XL13ZXC01	8-pin TSSOP	Commercial, 0 °C to 70 °C
CY2XL13ZXC01T	8-pin TSSOP – Tape and Reel	Commercial, 0 °C to 70 °C
CY2XL13ZXI01	8-pin TSSOP	Industrial, –40 °C to 85 °C
CY2XL13ZXI01T	8-pin TSSOP – Tape and Reel	Industrial, –40 °C to 85 °C

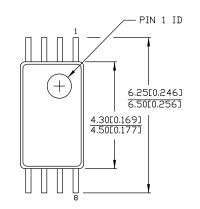
Ordering Code Definitions





Package Drawing and Dimensions

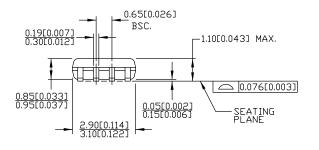
Figure 12. 8-pin TSSOP (4.40 mm Body) Z08.173/ZZ08.173 Package Outline, 51-85093

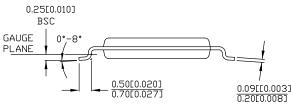


DIMENSIONS IN MMEINCHESJ MIN. MAX.

REFERENCE JEDEC MO-153

	PART #
Z08,173	STANDARD PKG.
ZZ08.173	LEAD FREE PKG.





51-85093 *D



Acronyms

Acronym	Description
ESD	Electrostatic Discharge
FAE	Field Application Engineer
HBM	Human Body Model
JEDEC	Joint Electron Devices Engineering Council
LCC	Leadless Chip Carrier
LVDS	Low-Voltage Differential Signaling
OE	Output Enable
PCB	Printed Circuit Board
PLL	Phase-Locked Loop
RMS	Root Mean Square
TSSOP	Thin Shrunk Small Outline Package
VCO	Voltage Controlled Oscillator
ХО	Crystal Oscillator

Document Conventions

Units of Measure

Symbol	Unit of Measure		
°C	degree Celsius		
MHz	megahertz		
μA	microampere		
μS	microsecond		
mA	milliampere		
mm	millimeter		
ns	nanosecond		
Ω	ohm		
%	percent		
pF	picofarad		
V	volt		
W	watt		



Document History Page

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Rev.	ECN No.	Submission Date	Orig. of Change	Description of Change		
**	2991849	07/23/2010	KVM	New data sheet.		
*A	4118896	09/10/2013	CINM	Updated Package Drawing and Dimensions: spec 51-85093 – Changed revision from *C to *D. Updated in new template. Completing Sunset Review.		



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